



60V N-Channel Enhancement Mode MOSFET

Voltage

60 V

Current

33 A

Features

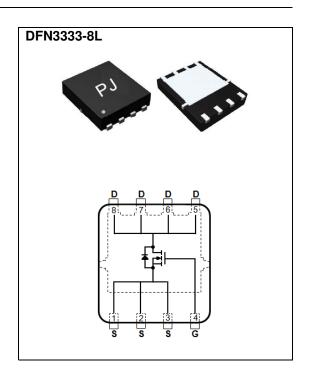
- $R_{DS(ON)}$, $V_{GS}@10V$, $I_D@15A<21m\Omega$
- $R_{DS(ON)}$, $V_{GS}@4.5V$, $I_{D}@8A<24m\Omega$
- High switching speed
- Improved dv/dt capability
- Low reverse transfer capacitance
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN3333-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.001 ounces, 0.03 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V_{DS}	60	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Gate-Source Voltage		V_{GS}	<u>+</u> 20	V	
Continuous Drain Current	T _C =25°C	I _D	33	А	
	T _C =100°C		21		
Pulsed Drain Current(Note 1)	T _C =25°C	I _{DM}	132		
Power Dissipation	T _C =25°C	Po	44.6	W	
	Tc=100°C		18		
Continuous Drain Current	T _A =25°C	lο	6		
	T _A =70°C		5	Α	
Power Dissipation	T _A =25°C		2.0	w	
Power Dissipation	T _A =70°C	PD	1.3		
Single Pulse Avalanche Energy ^(Note 6)		Eas	42	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~150	°C	
Typical Thermal Resistance ^(Note 4,5)	Junction to Case	Rejc	2.8	°C/W	
	Junction to Ambient	R _{0JA}	62.5		

• Limited only By Maximum Junction Temperature





Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Static						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	60	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =250uA	1.0	1.73	2.5	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =15A	-	18	21	mΩ
		V _{GS} =4.5V, I _D =8A	-	21	24	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V	-	-	1.0	uA
Gate-Source Leakage Current	lgss	V _{GS=±} 20V, V _{DS} =0V	-	-	<u>+</u> 100	nA
Dynamic ^(Note 5)			_			
Total Gate Charge	Qg	V _{DS} =30V, I _D =15A, V _{GS} =10V ^(Note 1,2)	-	28	-	nC
Gate-Source Charge	Qgs		_	3.5	-	
Gate-Drain Charge	Q_{gd}		-	6.5	-	
Input Capacitance	Ciss	V _{DS} =20V, V _{GS} =0V, f=1.0MHZ	-	1680	-	pF
Output Capacitance	Coss		-	115	-	
Reverse Transfer Capacitance	Crss	I=1.0IVIDZ	-	85	-	
Turn-On Delay Time	td _(on)	\/ 00\/ I 1A	-	7.2	-	ns
Turn-On Rise Time	t r	V_{DD} =30V, I_D =1A, V_{GS} =10V, R_G =6 Ω (Note 1.2)	-	38	-	
Turn-Off Delay Time	td _(off)		-	34	-	
Turn-Off Fall Time	t _f	(1000 1,2)	-	8.2	-	
Drain-Source Diode						
Maximum Continuous Drain-Source	l.		-	-	33	A
Diode Forward Current	I _S					
Reverse Recovery Time	V _{SD}	I _S =1A, V _{GS} =0V	-	0.68	1	V

NOTES:

- 1. Pulse width<a>300us, Duty cycle<a>2%
- 2. Essentially independent of operating temperature typical characteristics
- 3. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J =25°C.
- 4. The maximum current rating is package limited
- 5. Rejah is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper
- 6. The test condition is L=0.1mH, I_{AS}=29A, V_{DD} =25V, V_{GS} =10V, Starting T_J =25°C
- 7. Guaranteed by design, not subject to production testing.





TYPICAL CHARACTERISTIC CURVES

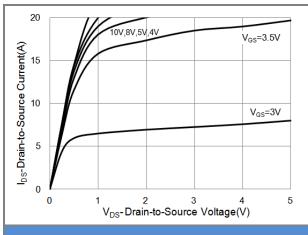


Fig.1 On-Region Characteristics

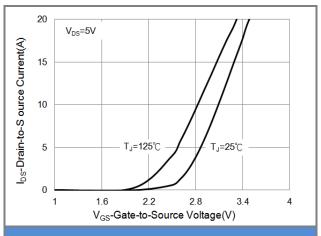


Fig.2 Transfer Characteristics

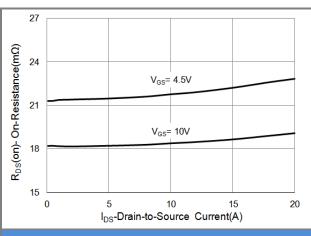


Fig.3 On-Resistance vs. Drain Current

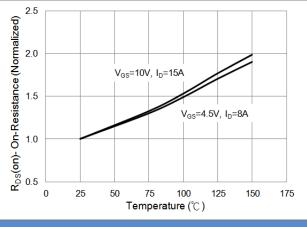
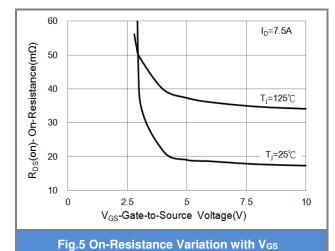


Fig.4 On-Resistance vs. Junction temperature



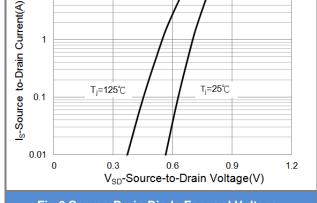


Fig.6 Source-Drain Diode Forward Voltage

10





TYPICAL CHARACTERISTIC CURVES

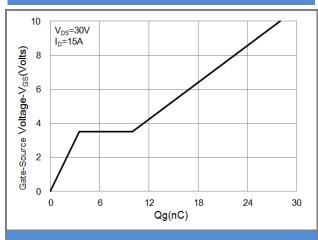


Fig.7 Gate-Charge Characteristics

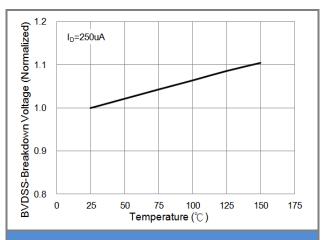


Fig.8 Breakdown Voltage Variation vs. Temperature

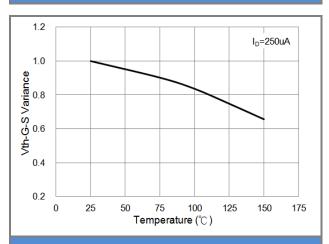


Fig.9 Threshold Voltage Variation with Temperature

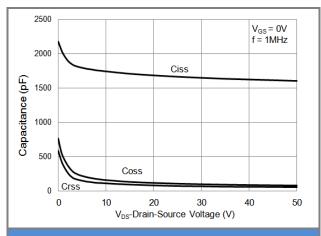
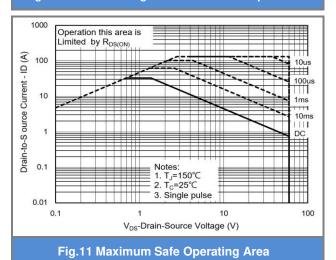


Fig.10 Capacitance vs. Drain-Source Voltage







TYPICAL CHARACTERISTIC CURVES

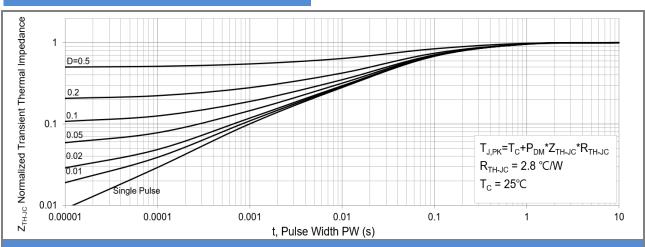


Fig.12 Normalized Transient Thermal Impedance vs. Pulse Width

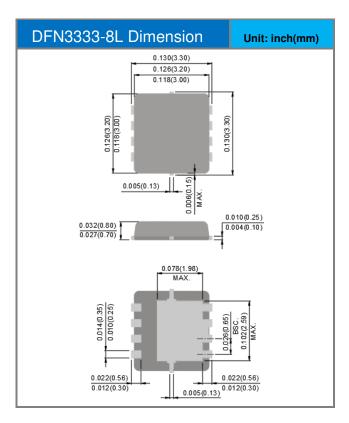


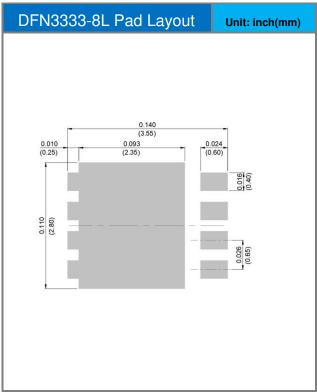


Part No. Packing Code Version

Part No. Packing Code	Package Type	Packing Type	Marking	Version
PJQ4466AP_R2_00001	DFN3333-8L	5K pcs / 13" reel	4466	Halogen free RoHS compliant

Packaging Information & Mounting Pad Layout









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